

MOS FIELD EFFECT TRANSISTOR 2SK2984

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching application.

FEATURES

· Low on-resistance

RDS(on)1 = 10 m Ω (MAX.) (VGS = 10 V, ID = 20 A)

 $R_{DS(on)2} = 15 \text{ m}\Omega \text{ (MAX.)} \text{ (Vgs} = 4.5 \text{ V, Ip} = 20 \text{ A)}$

- Low Ciss Ciss = 2850 pF TYP.
- · Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK2984	TO-220AB
2SK2984-S	TO-262
2SK2984-ZJ	TO-263

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage Note1	VDSS	30	V	
Gate to Source Voltage Note2	Vgss	±20	V	
Drain Current (DC)	I _{D(DC)}	±40	Α	
Drain Current (pulse) Note3	D(pulse)	±160	Α	
Total Power Dissipation (TA = 25°C)	P⊤	1.5	W	
Total Power Dissipation (Tc = 25°C)	PT	60	W	
Channel Temperature	Tch	150	°C	
Storage Temperature	Tstg	-55 to +150	°C	

Notes.1 Vgs = 0 V

2 Vps = 0 V

3 PW \leq 10 μ s, Duty Cycle \leq 1 %

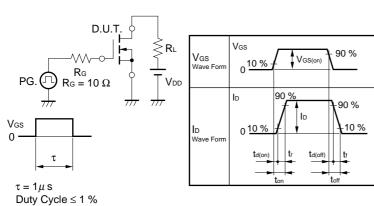
The information in this document is subject to change without notice.



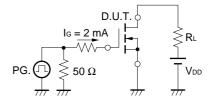
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 20 A		6.5	10	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 20 A		8.5	13	mΩ
Gate to Source Cut-off Voltage	VGS(off)	Vps = 10 V, Ip = 1 mA	1.0	1.5	2.0	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 20 A	18	36		S
Drain Leakage Current	Inss	V _{DS} = 30 V, V _{GS} = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V		2600		pF
Output Capacitance	Coss	Ves = 0 V f = 1 MHz		1150		pF
Reverse Transfer Capacitance	Crss			500		pF
Turn-on Delay Time	t _{d(on)}	ID = 20 A		70		ns
Rise Time	tr	VGS(on) = 10 V		1100		ns
Turn-off Delay Time	t _{d(off)}	$V_{DD} = 15 \text{ V}$ $R_G = 10 \Omega$		210		ns
Fall Time	t f			310		ns
Total Gate Charge	Q _G	I _D = 40 A V _{DD} = 24 V V _{GS} = 10 V		65		nC
Gate to Source Charge	Qgs			9.5		nC
Gate to Drain Charge	Q _{GD}			12.5		nC
Body Diode Forward Voltage	V _F (S-D)	IF = 40 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 40 A, VGS = 0 V		50		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A /μS		100		nC

TEST CIRCUIT 1 SWITCHING TIME

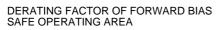


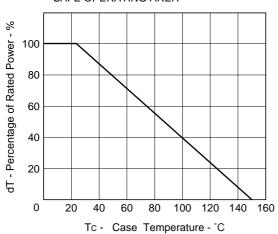
TEST CIRCUIT 2 GATE CHARGE



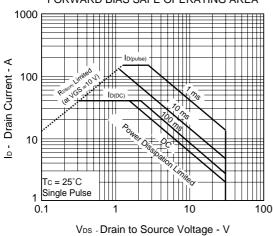


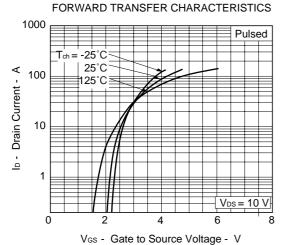
TYPICAL CHARACTERISTICS (TA = 25 °C)



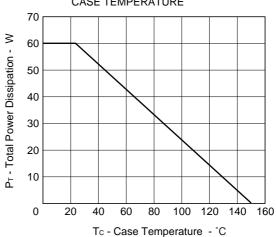


FORWARD BIAS SAFE OPERATING AREA

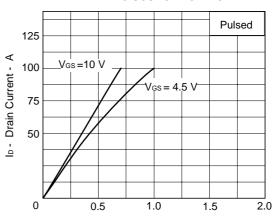




TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

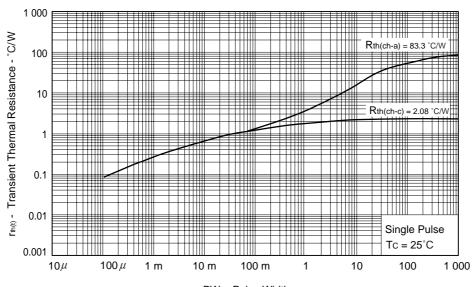


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



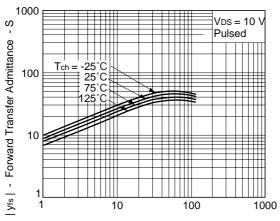
 $V_{\text{\scriptsize DS}}$ - $\,$ Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



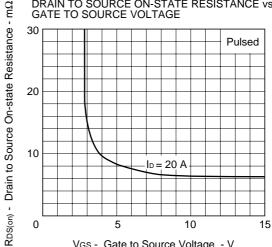
PW - Pulse Width - s





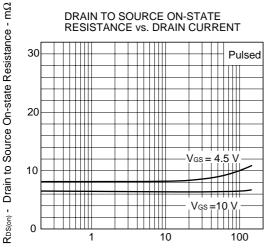
Ip- Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



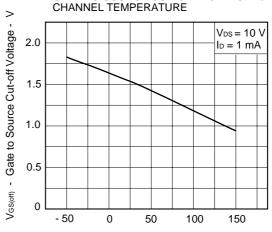
Vgs - Gate to Source Voltage - V

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

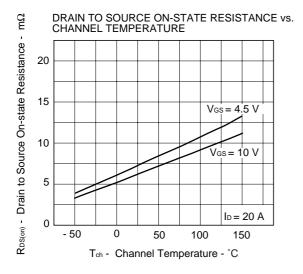


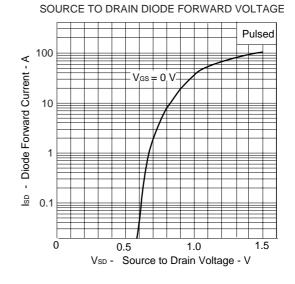
ID - Drain Current - A

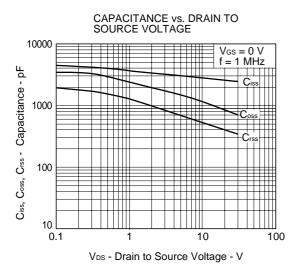
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

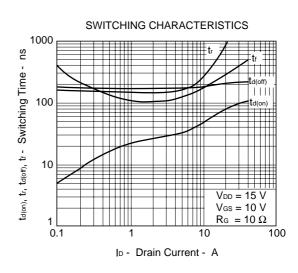


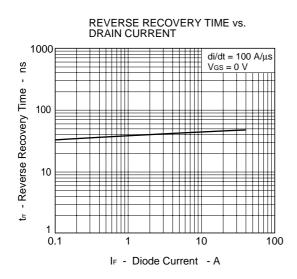
 $\mathsf{T}_\mathsf{ch}\,$ - Channel Temperature - $^\circ\mathsf{C}$

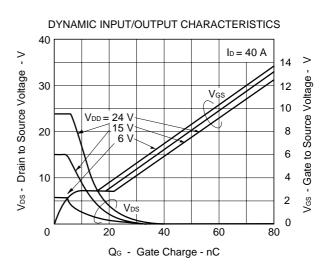








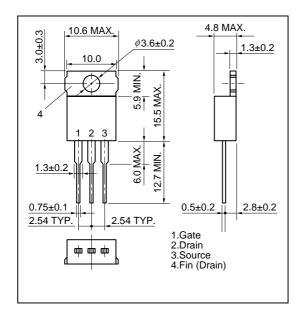




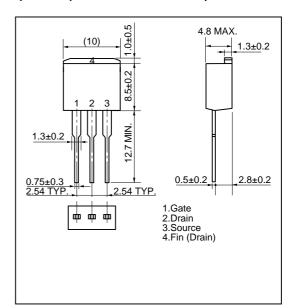


PACKAGE DRAWINGS (Unit:mm)

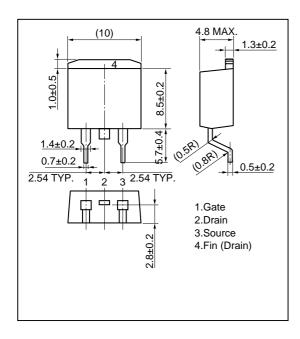
1)TO-220AB (MP-25)



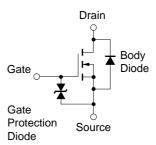
2)TO-262 (TO-220 Fin Cut:MP-25S)



3)TO-263 (JEDEC TYPE:MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

2SK2984



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Anti-radioactive design is not implemented in this product.

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